

# Forward Calorimetry

S.Schuwalow, DESY

- LumiCal
- BeamCal & Pair Monitor
- Data Transfer & Integration
- Priority R&D Topics
- Challenges of Very Forward Detectors

# Calorimeters in the very forward region (14 mrad xa)

1st conical BP

LumiCal  
Sensitive

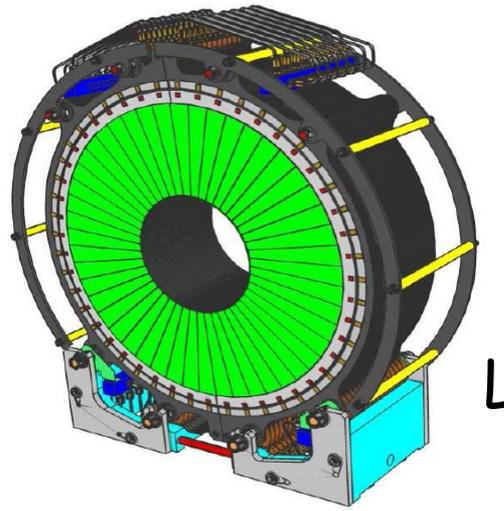
BeamCal

ECal ring

Flange &  
bellow

LHCal

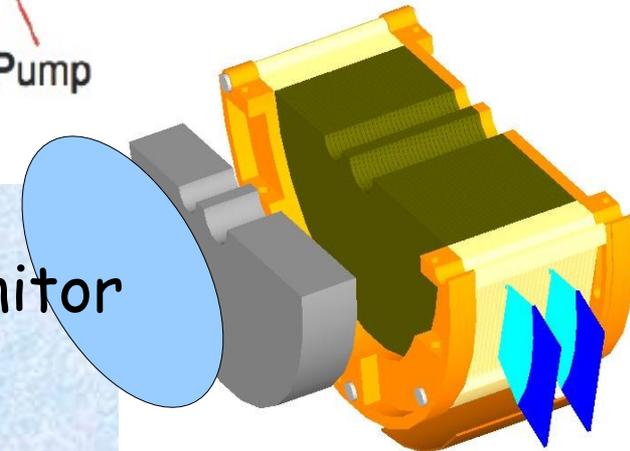
Pump



LumiCal

Pair Monitor

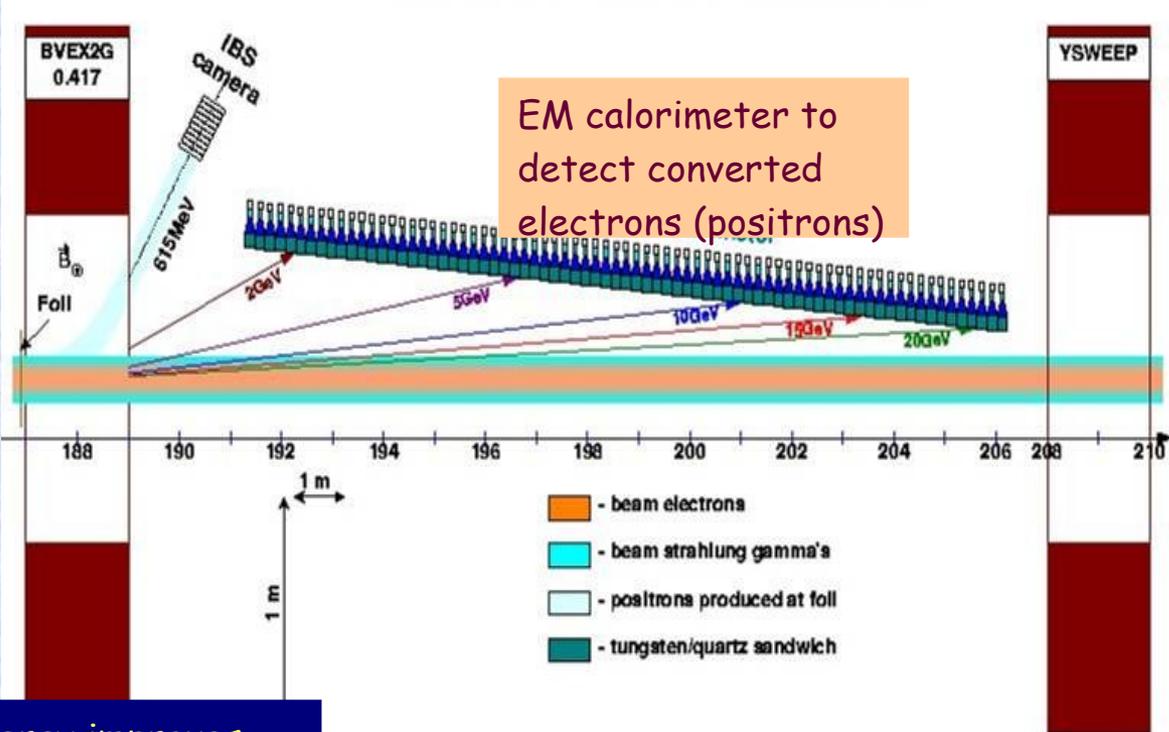
BeamCal



# + one more calorimeter, GamCal

~ 180 m from IP  
 < 1 mrad aperture (beamstrahlung photons)

Integrated Beamstrahlung Spectrometer



EM calorimeter to detect converted electrons (positrons)

Thin foil to convert beamstrahlung photons

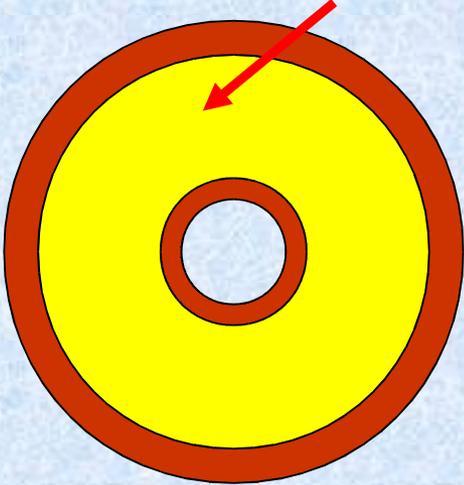
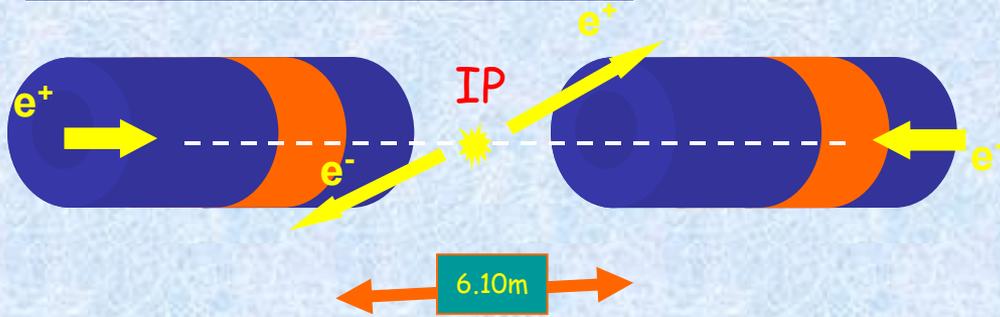


Measuring only the total photon energy improves the measurement of beam parameters significantly! (reduced correlations)  
 Also sensitive at low luminosities

# LumiCal

## Fiducial volume for event counting

Precise Luminosity measurement  
 Gauge process:  $e^+ e^- \rightarrow e^+ e^- (\gamma)$



$$\mathcal{L} = N / \sigma$$

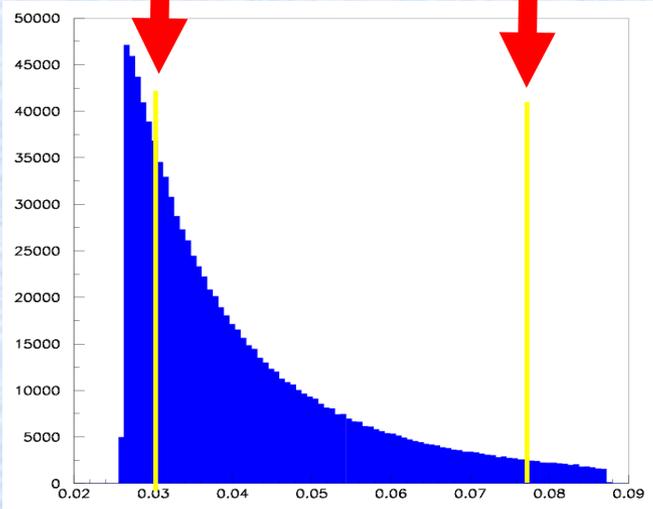
Count Bhabha events

From theory

Goal: Precision  $< 10^{-3}$

- Challenges:
- compact calorimeter (small Moliere radius)
  - small bias in  $\theta$  ( $< \mu\text{rad}$ )
  - small bias in energy scale (0.1%)

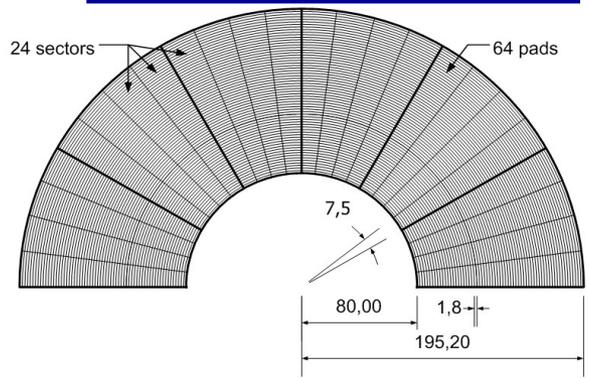
Events



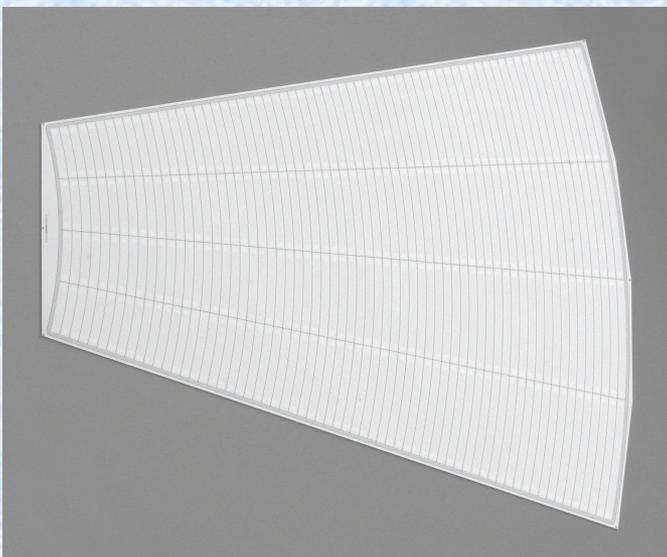
Theta, (rad)

# LumiCal Sensors

## Half sensor plane (design)



## Prototype sector (March 2009)



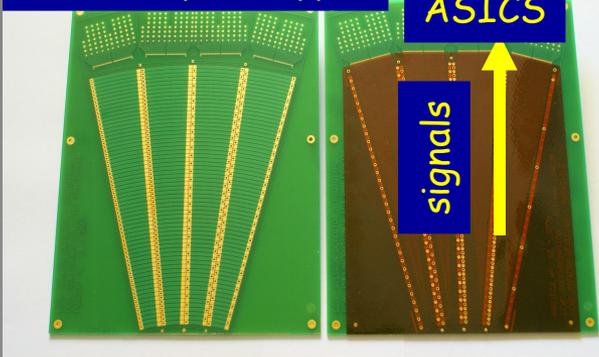
20 April 2009

N-type silicon, p<sup>+</sup> strips, n<sup>+</sup> backplane,  
 Crystal Orientation <100>  
 320 μm thickness ± 15 μm  
 Strip pitch: 1800 μm  
 Strip p<sup>+</sup> width: 1600 μm  
 Strip Al width: 1700 μm

Masks for prototypes ready (Hamamatsu)  
 Prototype sensors delivered in March

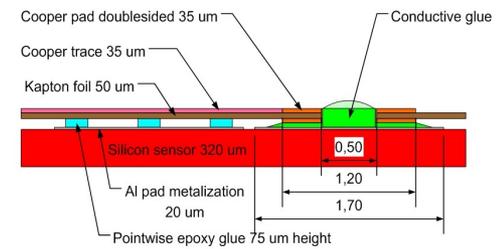
In parallel: development of the fanout

## Fan-out (prototype)

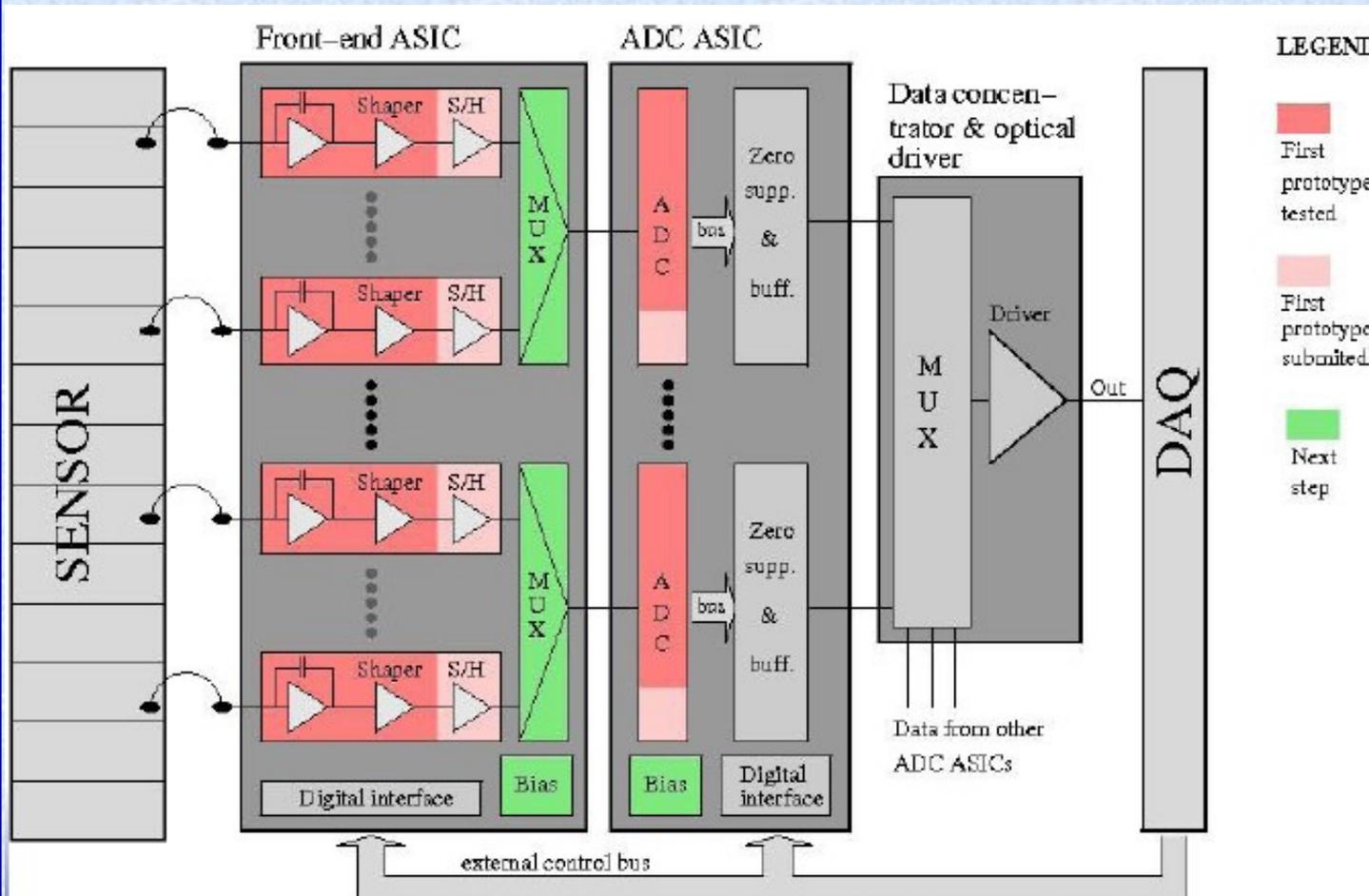


TILC09 Tsukuba

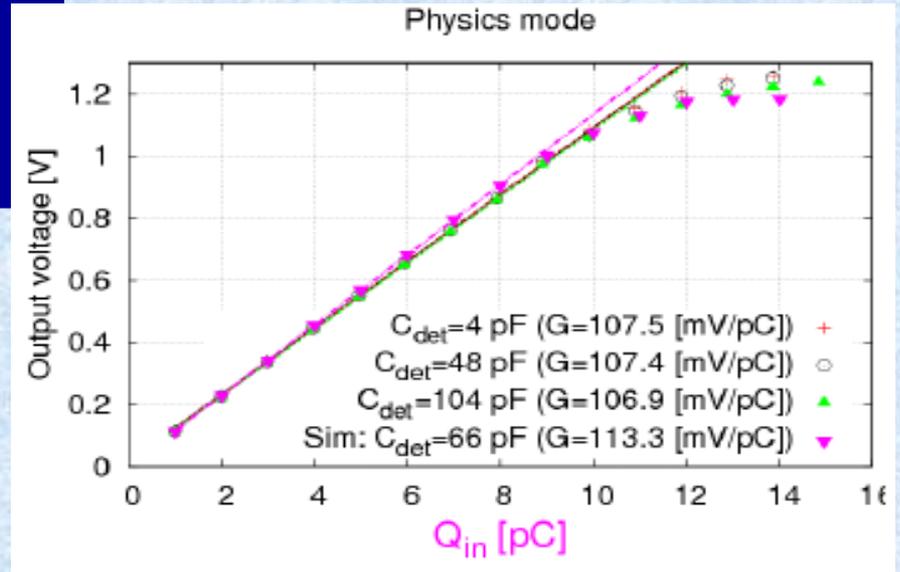
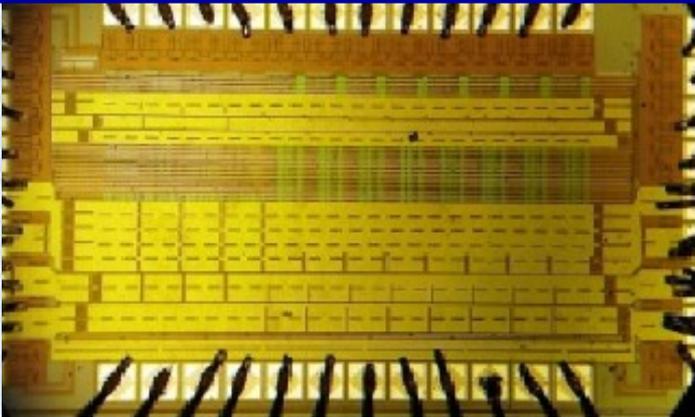
## Contact details



- One FE ASIC will contain 32 - 64 channels, 10 bit
  - One ADC will serve several channels (MC simulations not finished)
  - AMS 0.35  $\mu\text{m}$  technology
  - prototypes of the FE ASIC and ADC ASIC available,
- Tests of the FE ASICS so far promising.



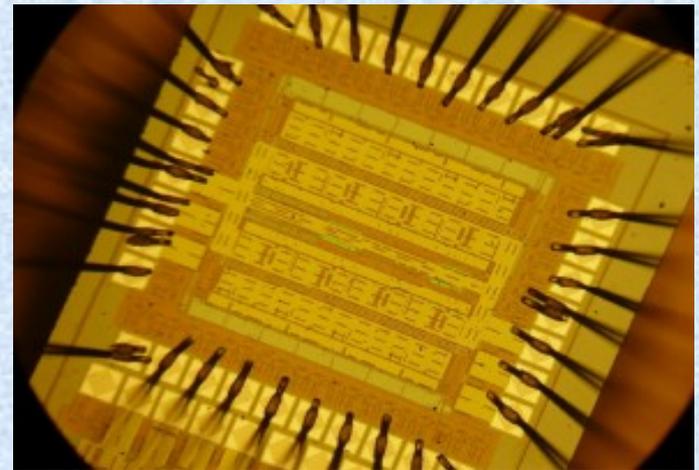
**FE ASIC:**  
 8 channels per chip, 4 with MOS feedback resistance,  
 4 with passive Rf feedback



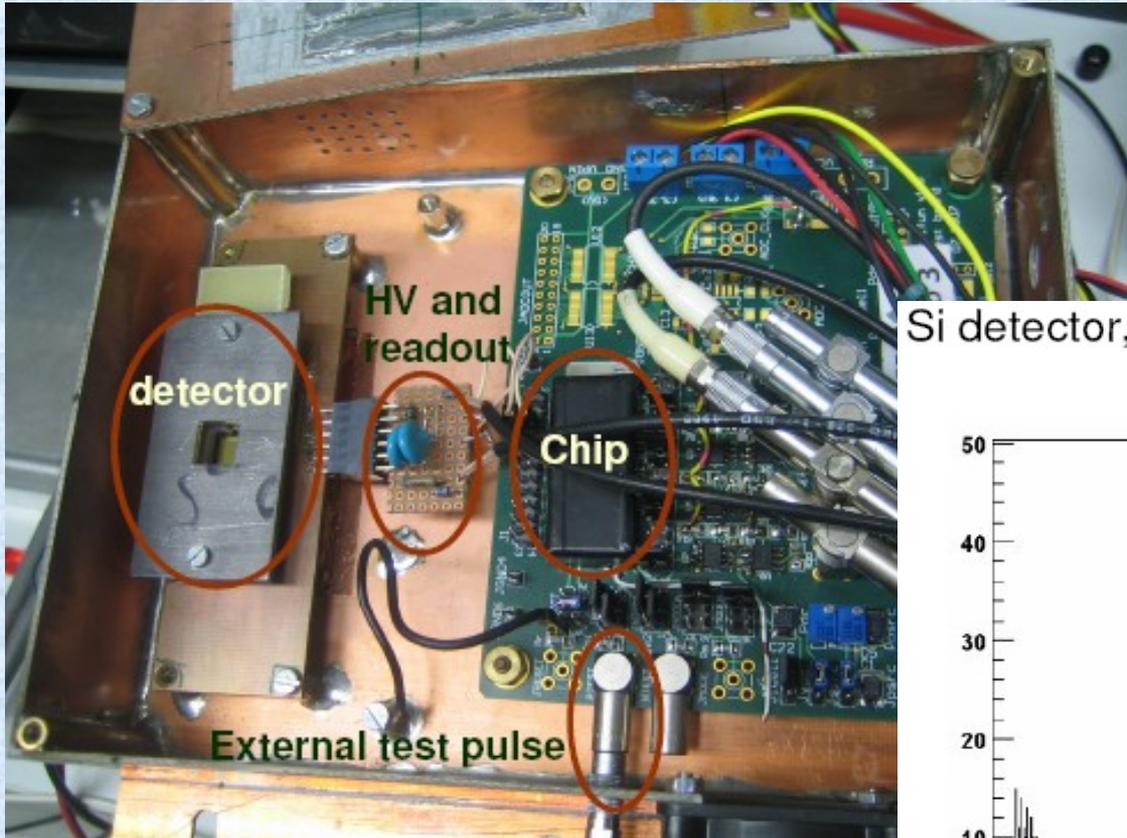
**ADC ASIC:**

- Pipeline architecture
- 10 bit resolution
- Maximum sampling rate 35 MHz

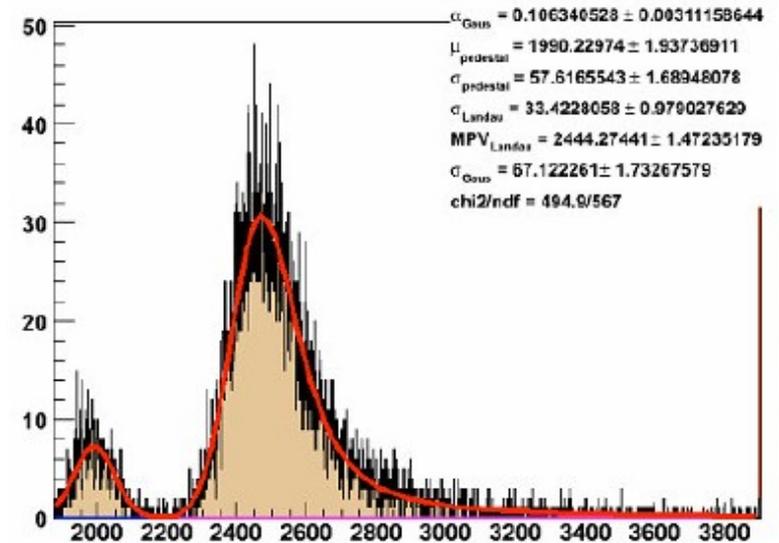
Submission ADC and DAC Sept. 2008  
 Prototypes obtained in November



First successful tests of the analog part with a single pad sensor

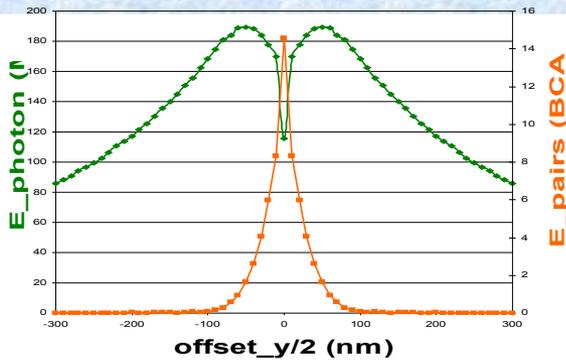


Si detector, MOS preamp.



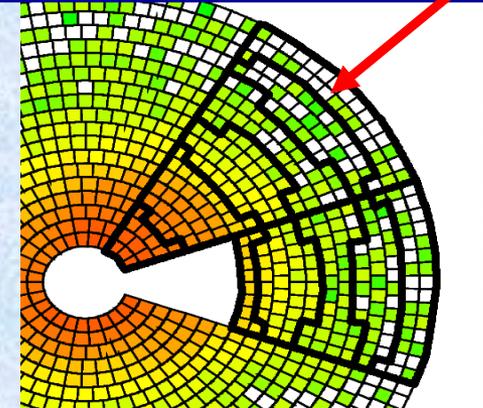
# BeamCal, Pair Monitor, GamCal

E\_pairs (BCAL) and E\_photon



BeamCal, Pair Monitor, GamCal  
Fast feedback for beam tuning, beam diagnostics using beamstrahlung;

Fast analog summation of pad-groups



Beamparameter determination on percent level

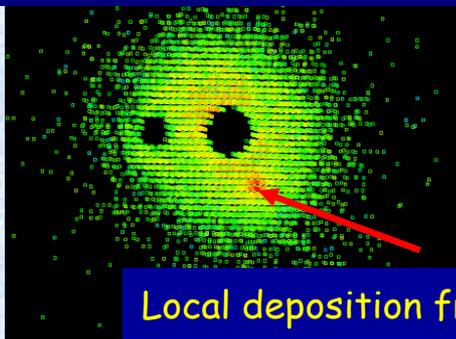
## BeamCal

Hermeticity,  
Electron veto at low angles

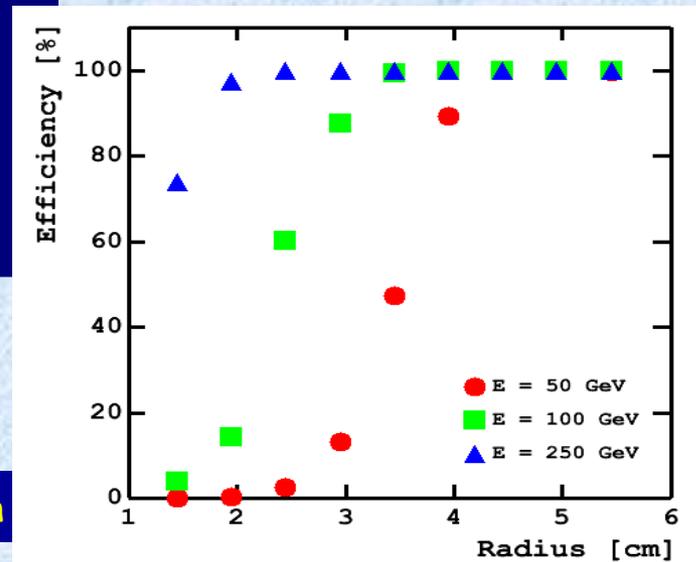
Mask for the inner detectors

### Challenges:

- compact calorimeter (small Moliere radius)
- radiation hard sensors (~ MGy)
- fast readout

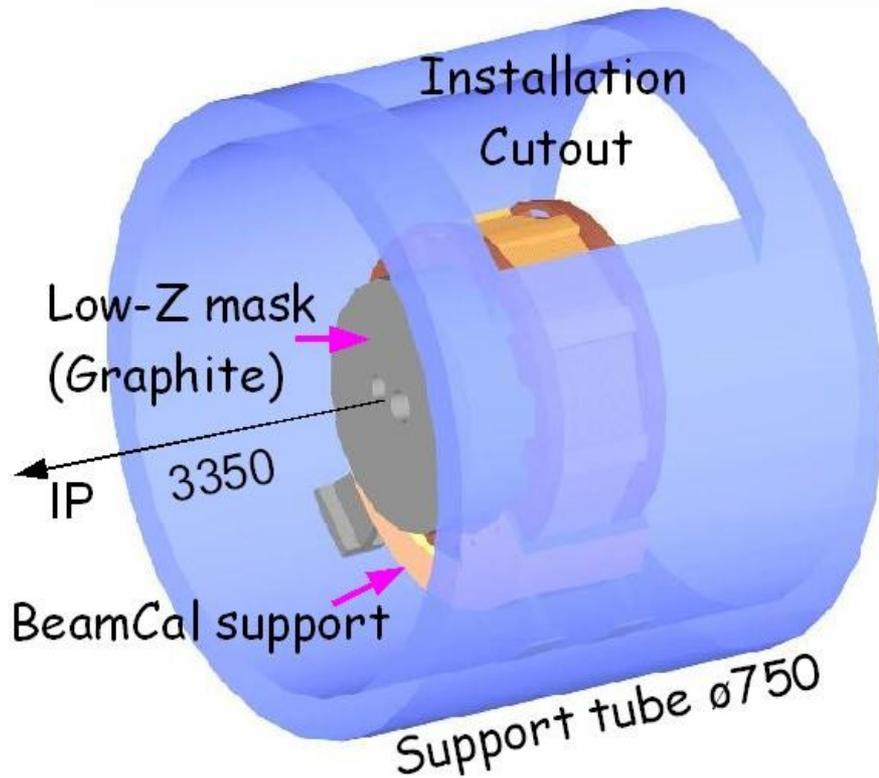


Local deposition from a single high energy electron

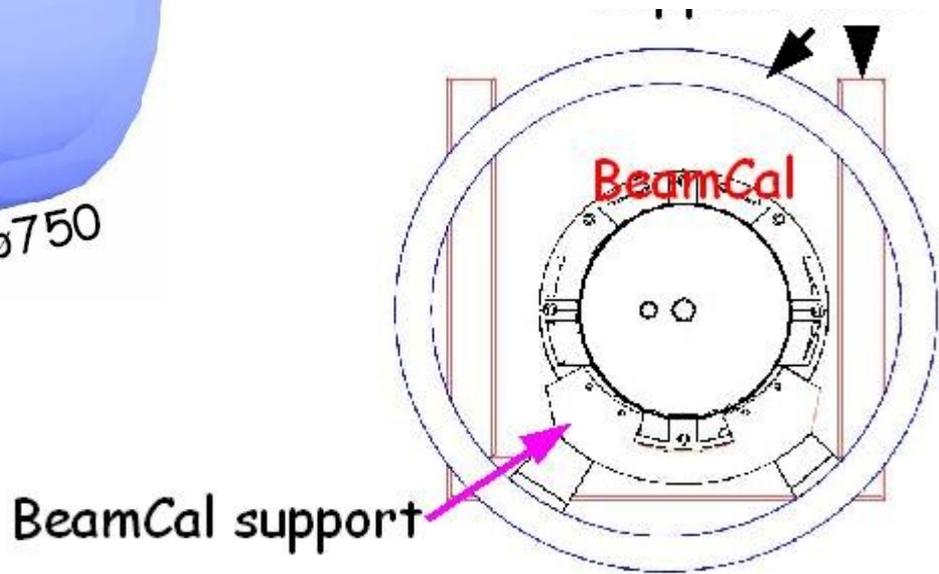
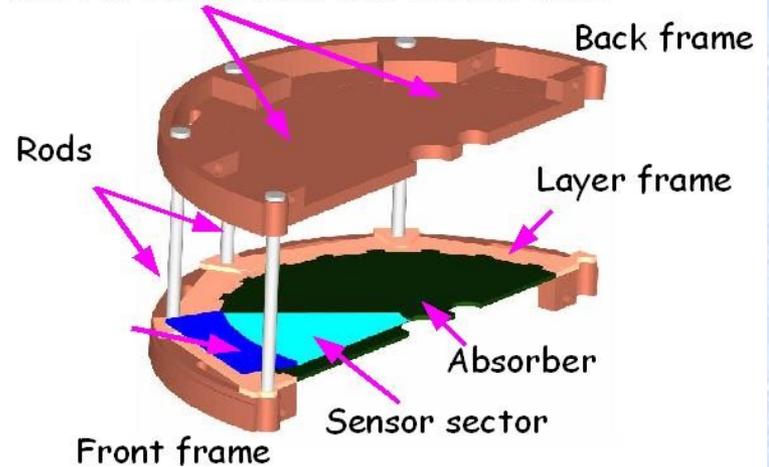


# BeamCal Mechanics

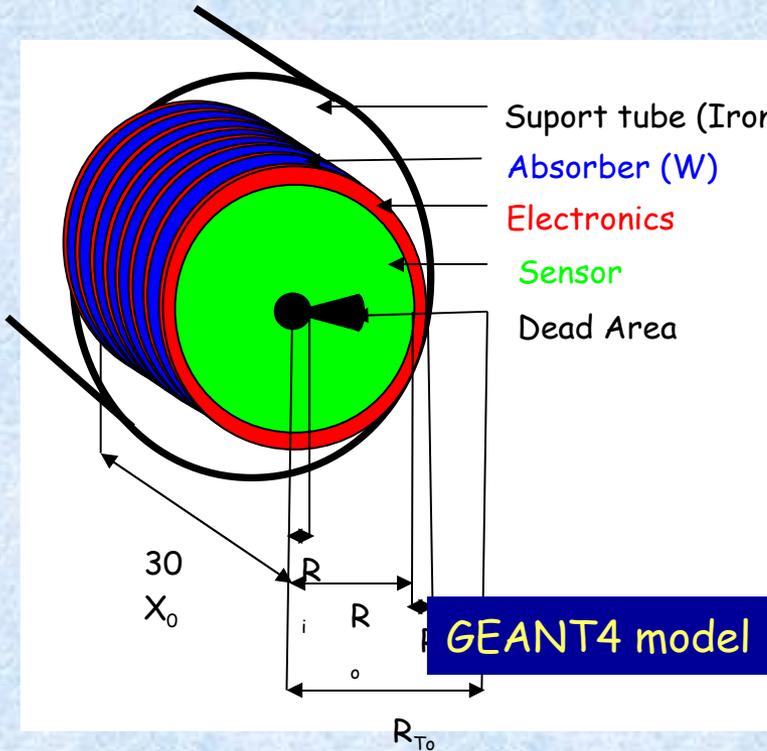
<http://www-zeuthen.desy.de/ILC/fcal/>



Place for connectors/extra electronics



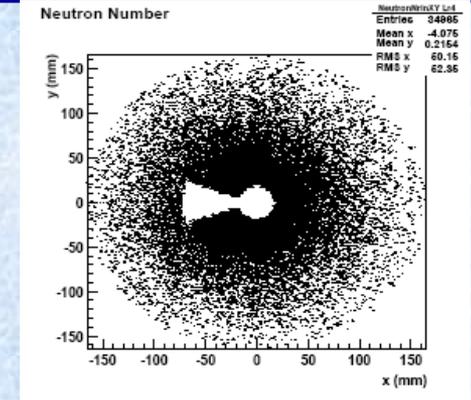
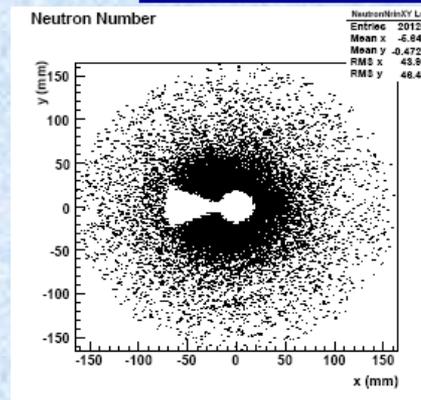
# Radiation Dose and neutron fluxes BeamCal



Electromagnetic dose for FE electronics:

< 100 Gy /year

Neutron flux inside sensors:



Neutron flux through FE electronics:

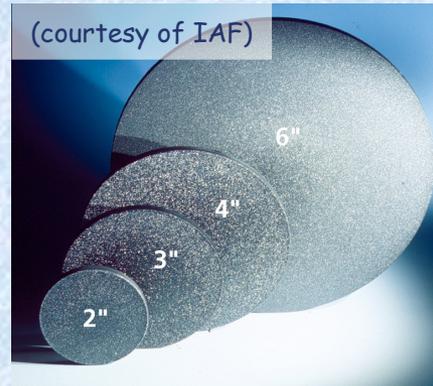
$10^{10}$  neutrons/mm<sup>2</sup>/year

Two different 'physics lists'

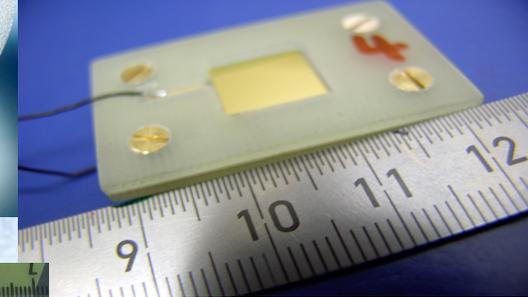
$10^{12}$  neutrons/mm<sup>2</sup>/year  
 (needs more detailed studies)

## pCVD diamonds:

- radiation hardness under investigation (e.g. LHC beam monitors, pixel detectors)
- advantageous properties like: high mobility, low  $\epsilon_R = 5.7$ , thermal conductivity

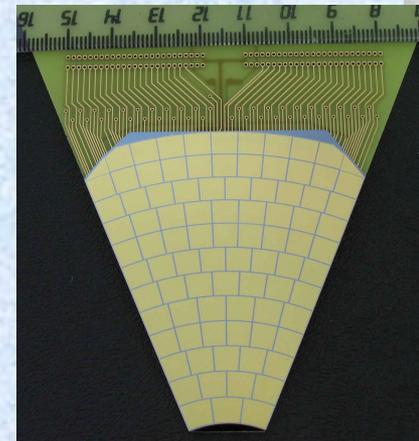


polycrystalline  
CVD diamond



## GaAs:

- semi-insulating GaAs, doped with Sn and compensated by Cr
- produced by the Siberian Institute of Technology



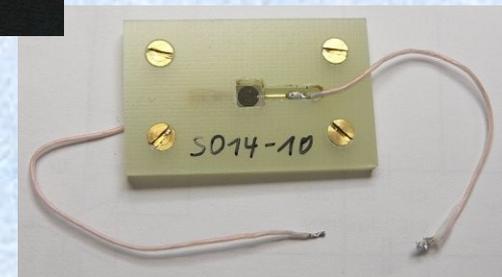
GaAs

## SC CVD diamonds:

- available in sizes of mm<sup>2</sup>

Sapphire, Quartz - first studies in the lab and at the beam (Dec 2008)

Single crystal  
CVD diamond



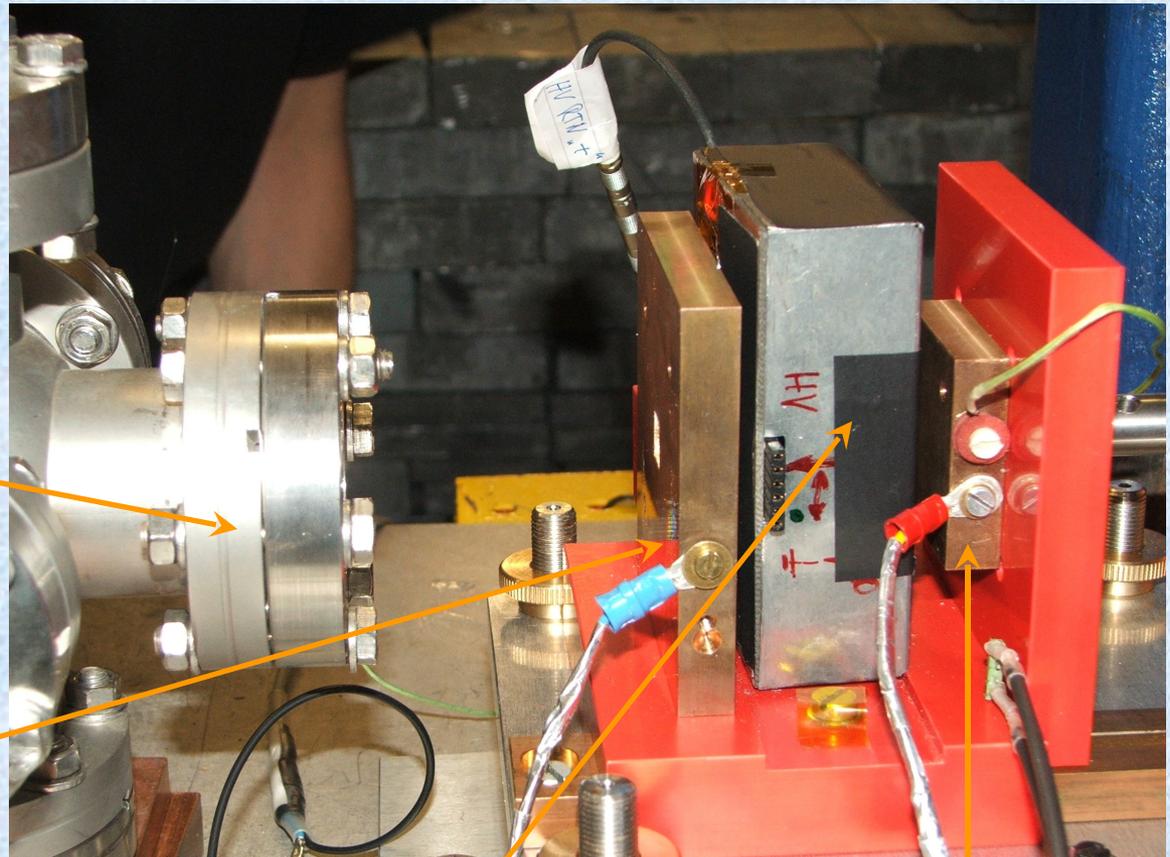
# Test Beam Equipment and sensor tests

Setup used for radiation hardness tests at the SDALINAC accelerator

TU Darmstadt

exit window  
of beam line

collimator ( $I_{Coll}$ )

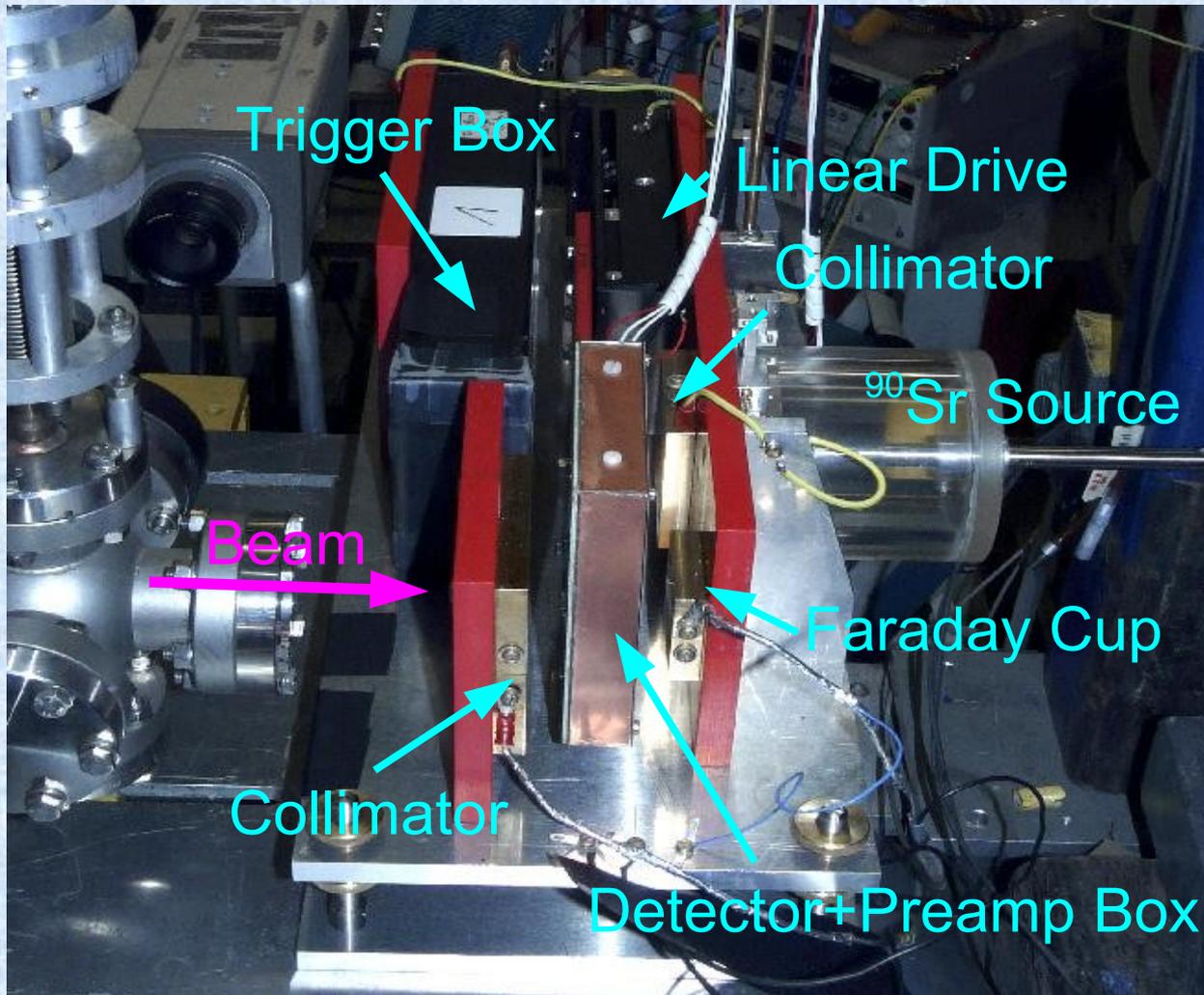


sensor box ( $I_{Dia}$ ,  $T_{Dia}$ , HV)

Faraday cup ( $I_{FC}$ ,  $T_{FC}$ )

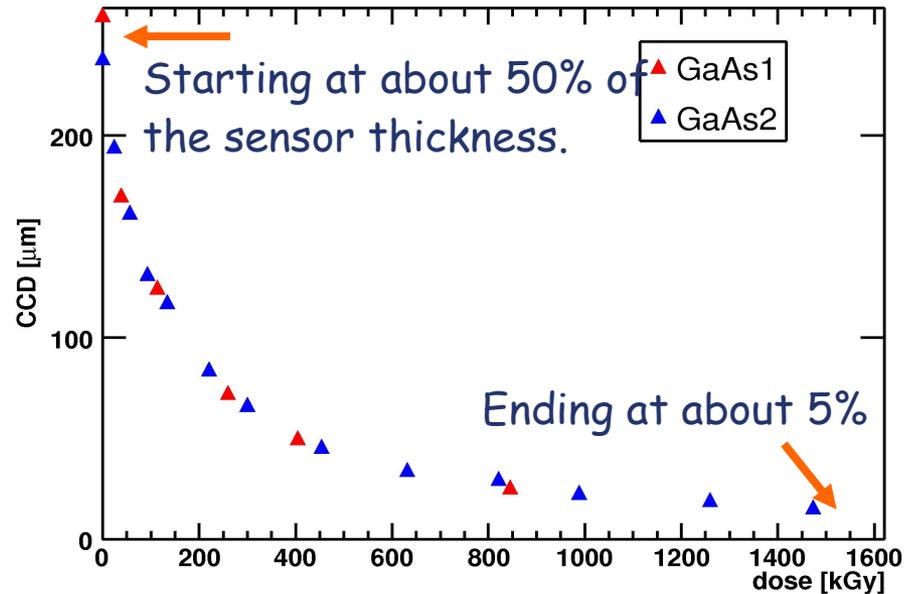
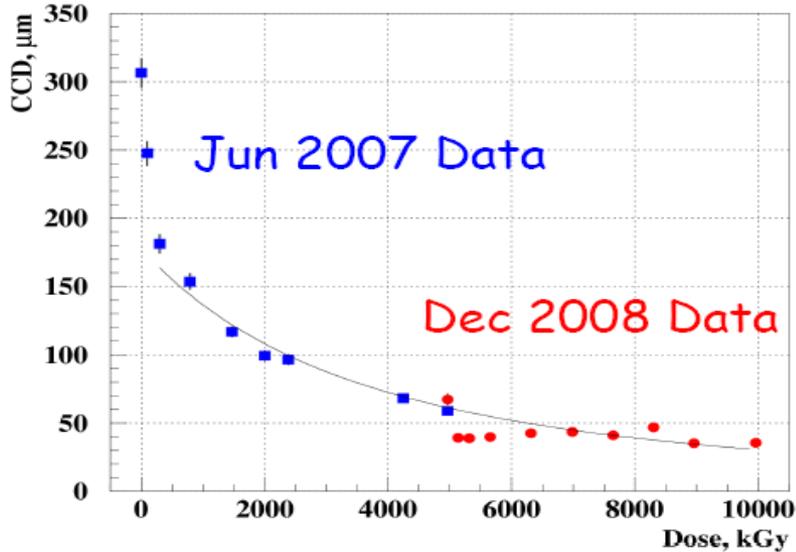
Completed and more comfortable: more efficient use of the beam

# Beam Pumping Tests

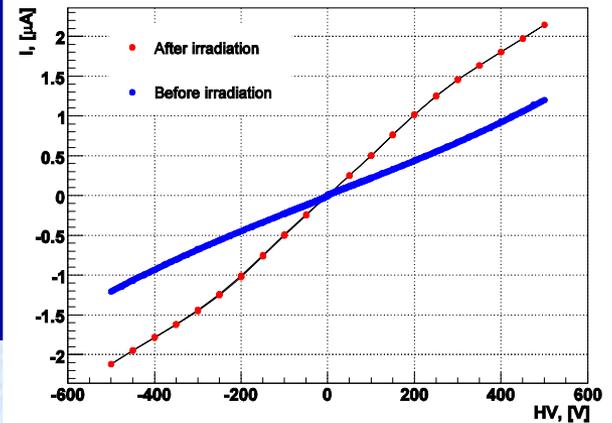
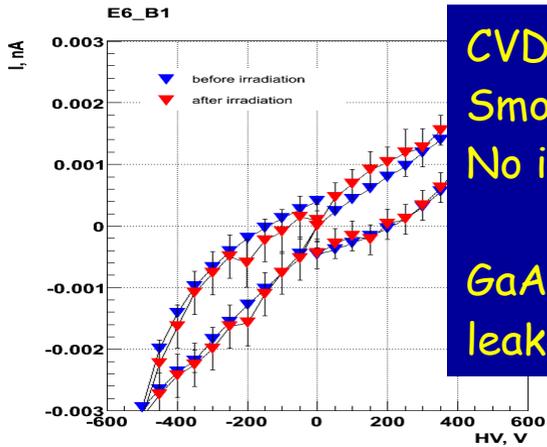


# Sensor irradiation tests

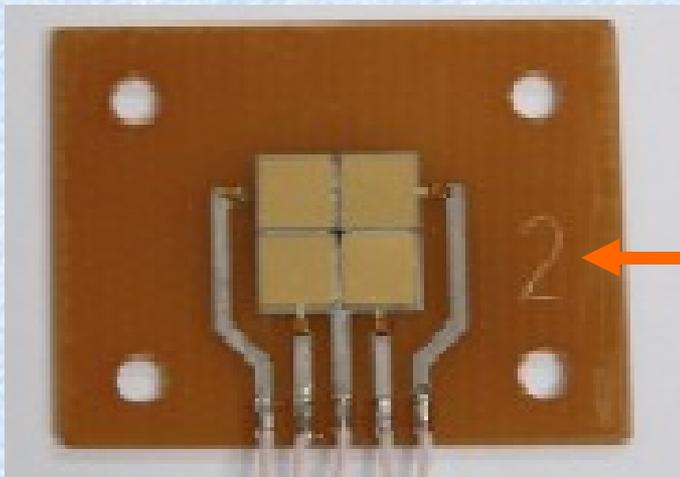
So14\_04 scCVD Diamond Irradiation



CVD diamond sensors:  
 Smooth degradation  
 No increase of leakage current.  
 GaAs: acceptable increase of the  
 leakage current



# Sensor tests



A new batch of GaAs sensors with Cr concentrations between  $10^{16}$  and  $10^{18}$  was recently delivered, testbeam measurements completed

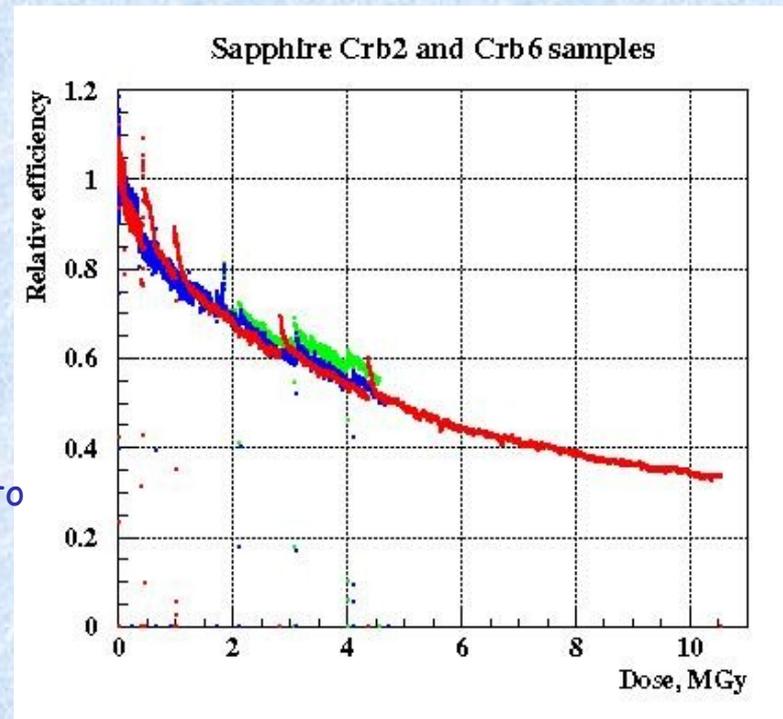
Sensors made of single crystal sapphire



CCE is a few %

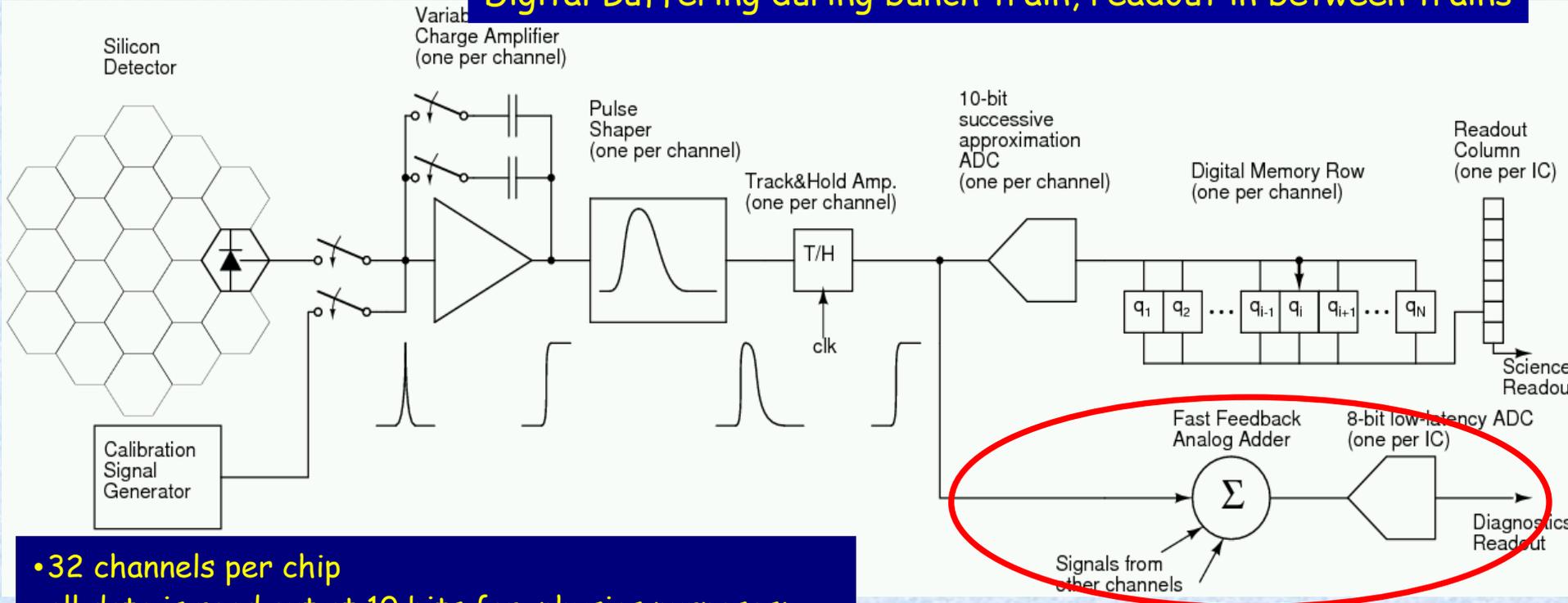
At a dose of  $\sim 12$  MGy  
 the signal current dropped to  
 30 % of its initial value!

$12$  MGy  $\sim 10^{17}$  e<sup>-</sup>/cm<sup>2</sup>



## Dedicated FE electronics for BeamCal, based on KPiX

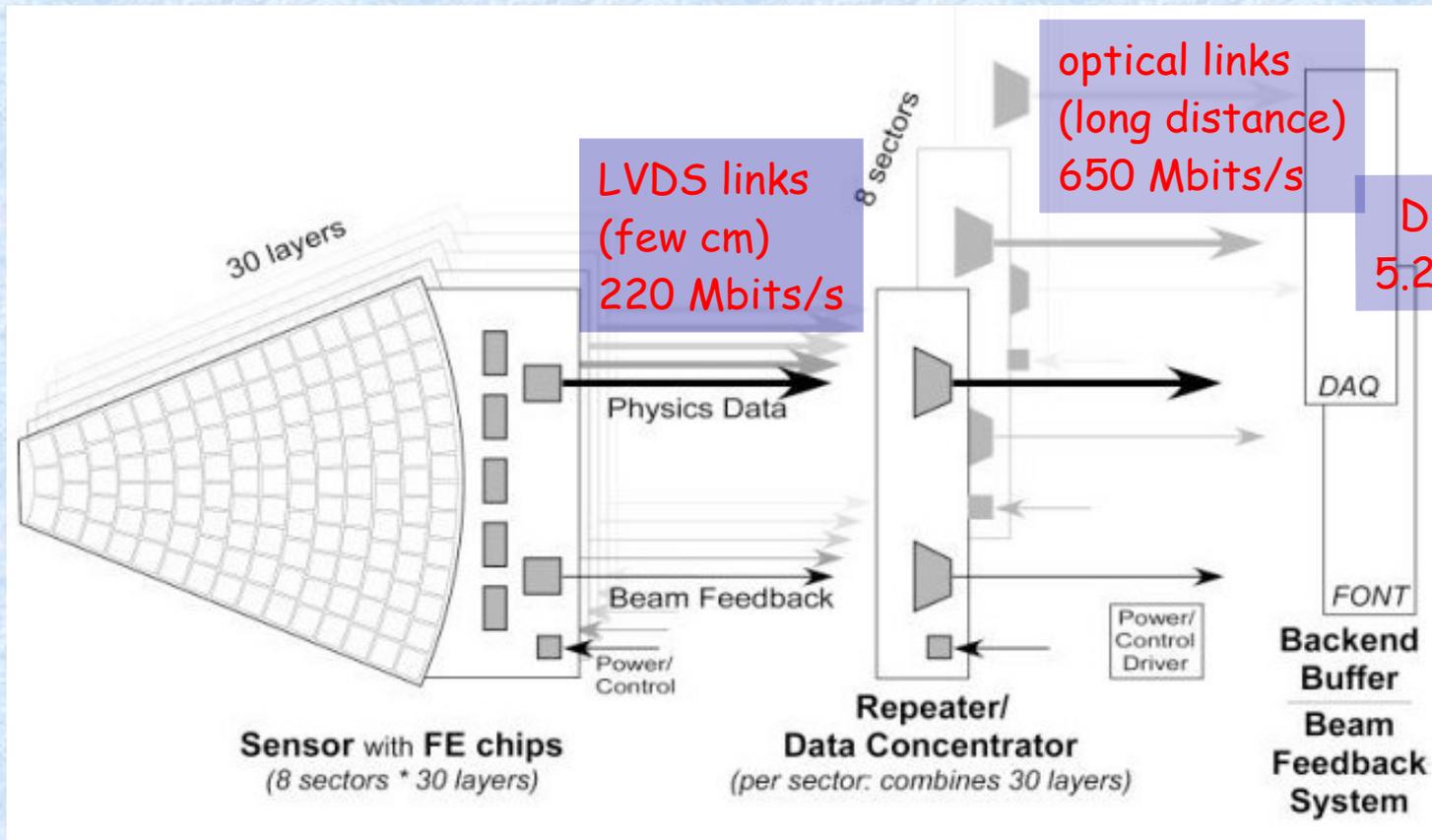
### Digital Buffering during bunch train, readout in between trains



- 32 channels per chip
- all data is read out at 10 bits for physics purposes;
- Low latency output, sum of all channels is read out after each bx at 8 bits for beam diagnosis (fast feedback)
- Prototype in 0.18- $\mu\text{m}$  TSMC CMOS technology

Fast analog adder for groups of pads used for fast feedback

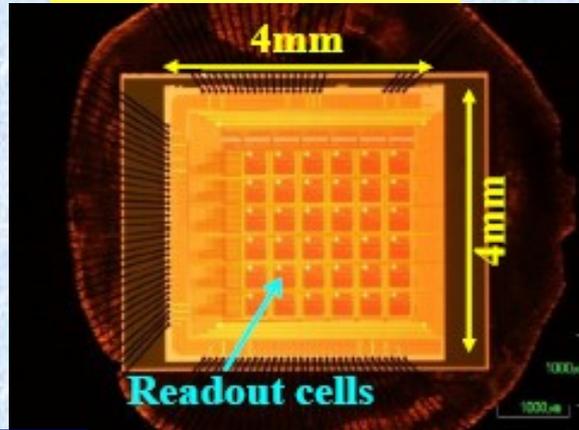
# BeamCal Data Transfer



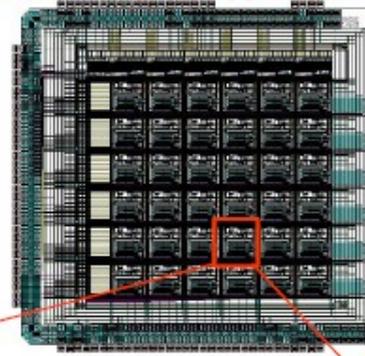
First step: concept based commercial components  
 Second step: dedicated prototype for a system test

# Pair Monitor

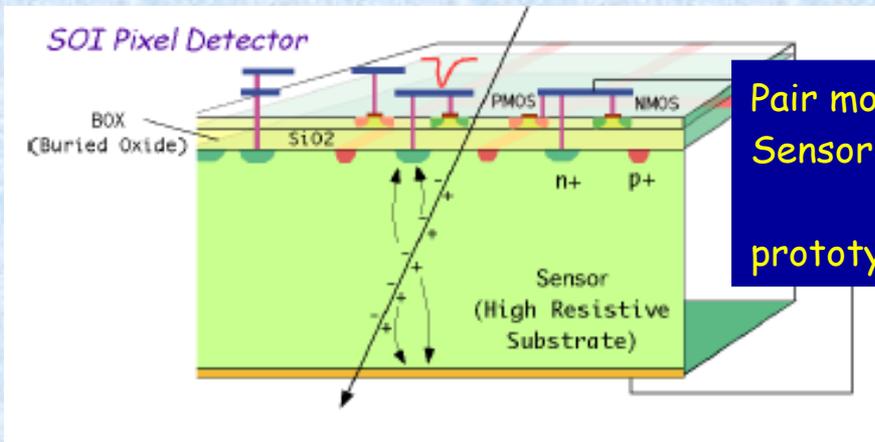
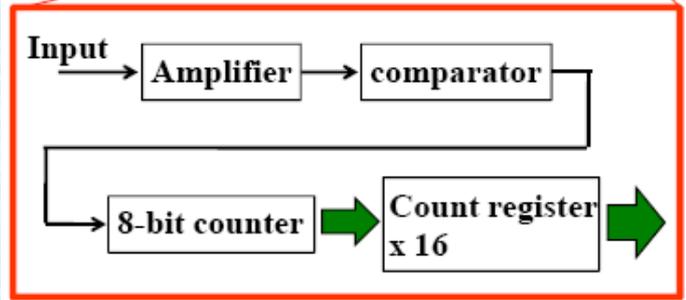
ASIC for the pair monitor  
 .25 mm TSMC technology  
 # of pixel: 36  
 Pixel size: 400 x 400  $\mu\text{m}^2$   
 Bump bonding to a sensor



Layout of prototype ASIC

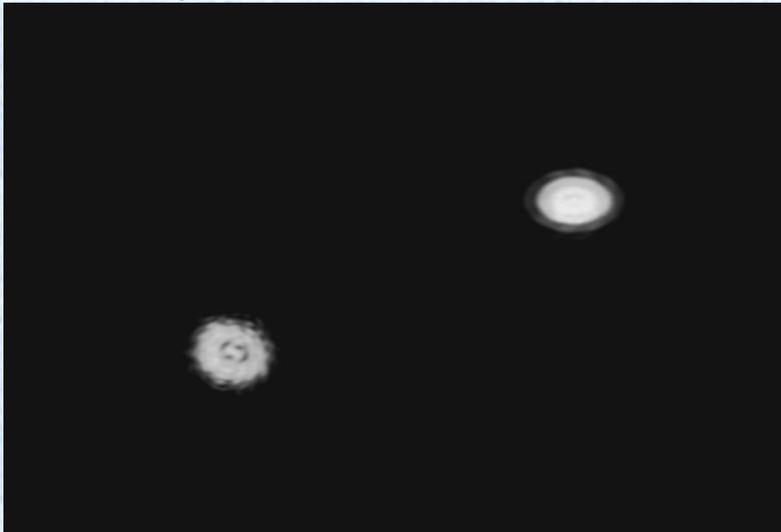
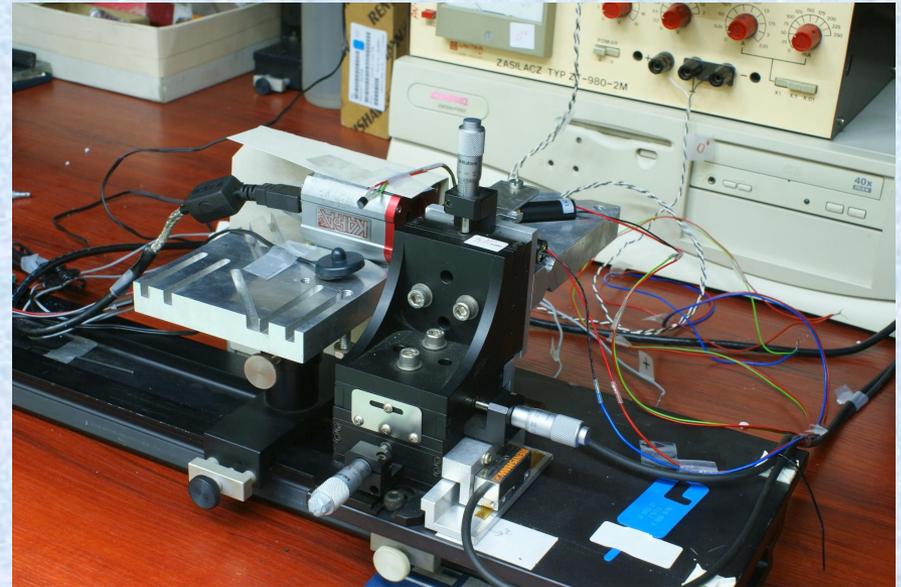
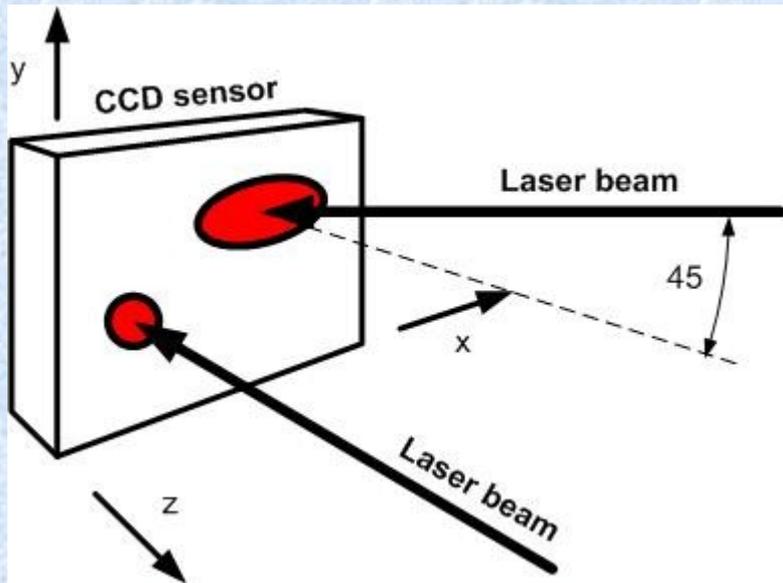


Prototype produced and successfully tested



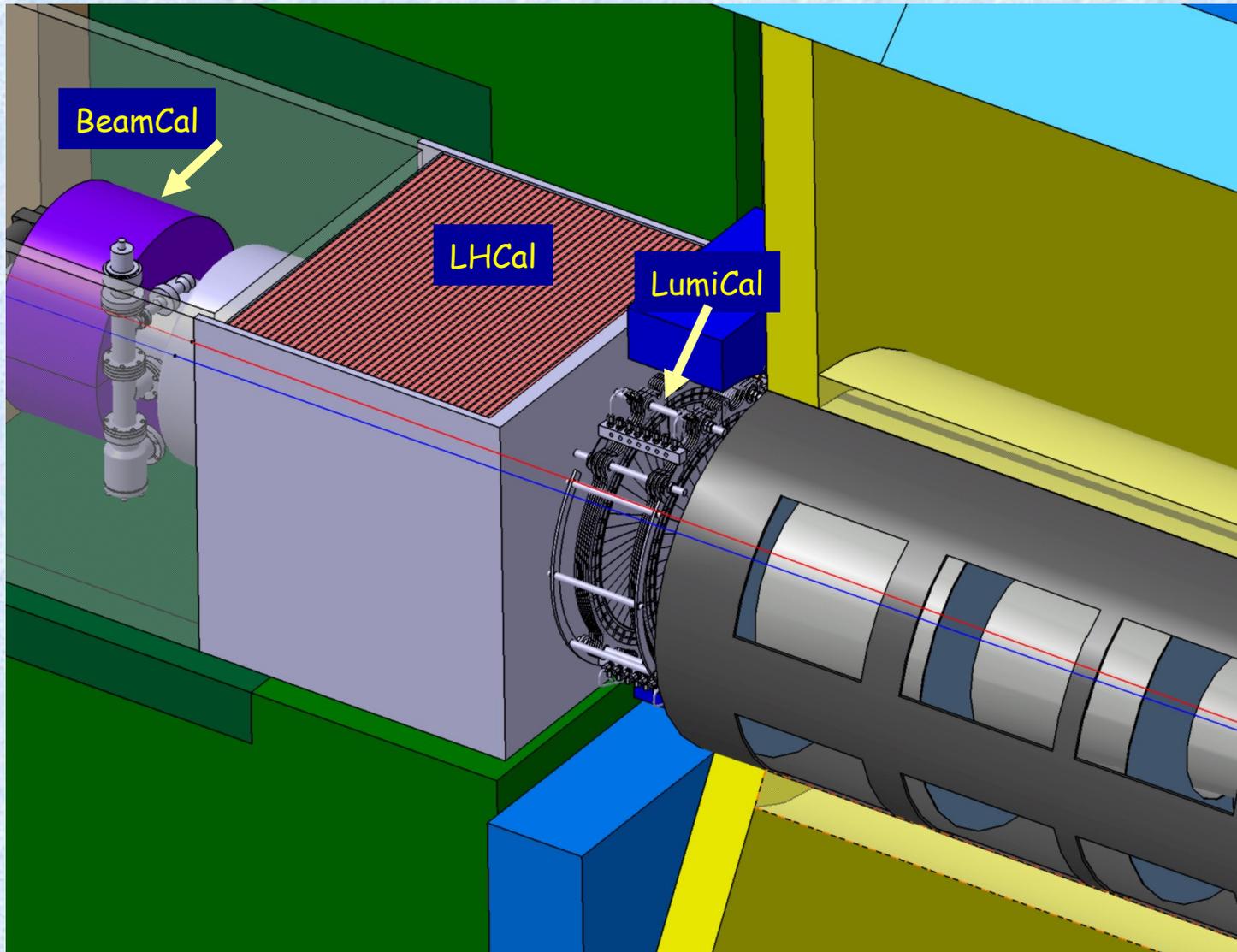
Pair monitor will use SoI technology,  
 Sensor and readout ASIC embeddd in the same wafer;  
 prototype 2009

# LumiCal Laser Position Monitoring



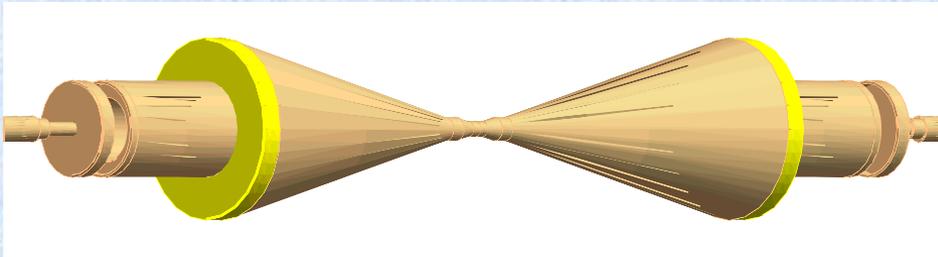
Over short distances accuracies reached:  
Displacements in the x-y plane:  $\pm 0.5 \mu\text{m}$   
Displacements in z direction:  $\pm 1.5 \mu\text{m}$

# ILD Integration



# Beampipe Design

Conical, central part Be



Pro: minimum material in front of LumiCal  
 Contra: vacuum, HOM, mechanics

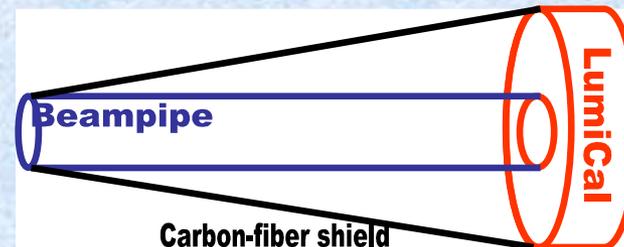
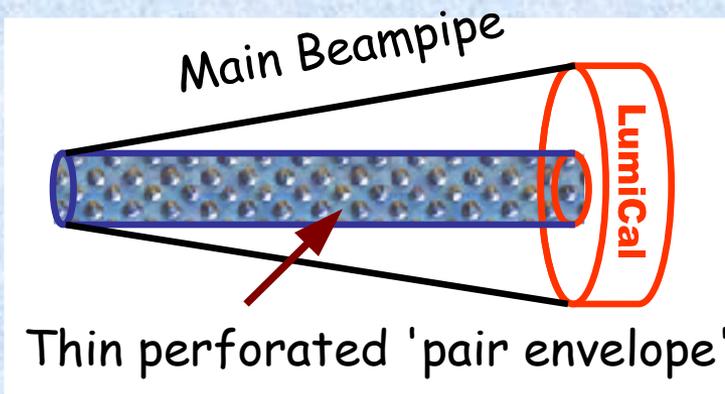
Cylindrical, full Be, inner radius 5.5 cm (14 mrad crossing angle)



Pro: facilitates mechanics, vacuum  
 Contra: material in front of LumiCal, pre-showering, electron measurement?

Possible solution of vacuum and HOM problems:

Difference in the Bhabha count rate:  
 $(1 \pm 2) \times 10^{-4}$ ; uncritical!  
 However: don't use the 'free space' for other purposes!



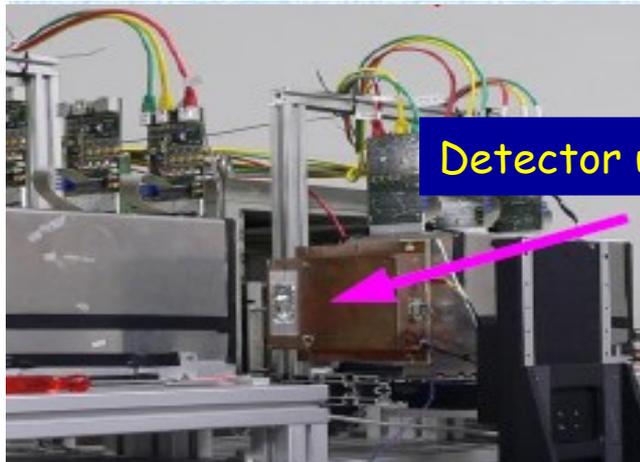
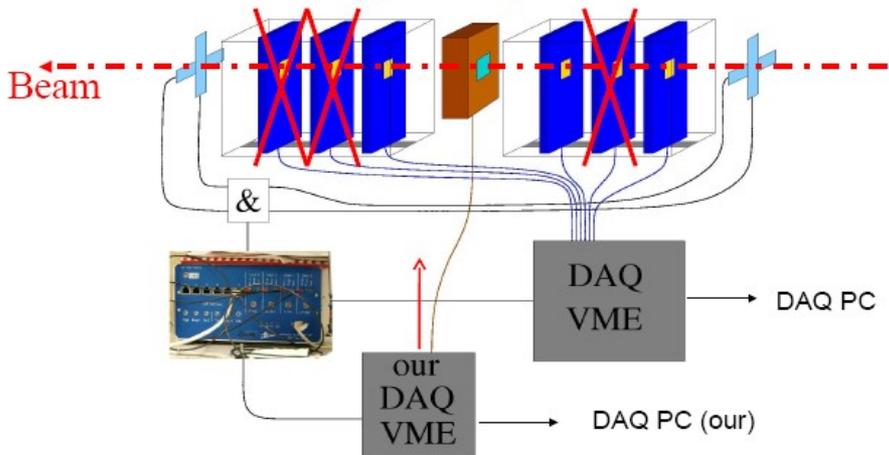
Possible solution

## Priority topics within FCAL:

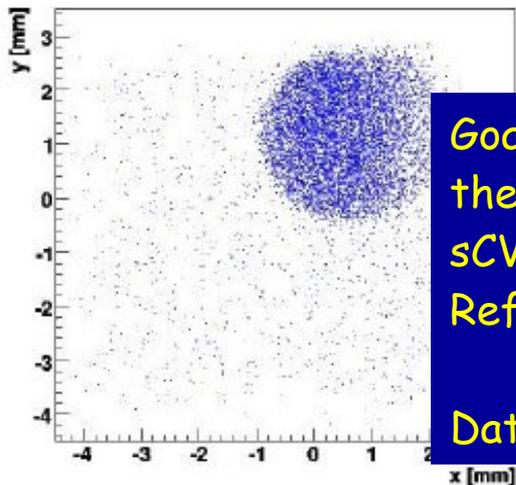
- Large area radiation hard sensors for calorimetry (BeamCal)
- Precise position measurement of electromagnetic showers (Sensors for LumiCal, position monitoring)
- ASICS with high readout speed, large dynamic range, large buffering depth and low power dissipation, allowing fast feedback for luminosity optimization
- Prototyping and test of more complex subsystems to prepare compact sampling calorimeters

# Sensor Tests

## Testbeam equipment for sensor performance studies using the EUDET telescope



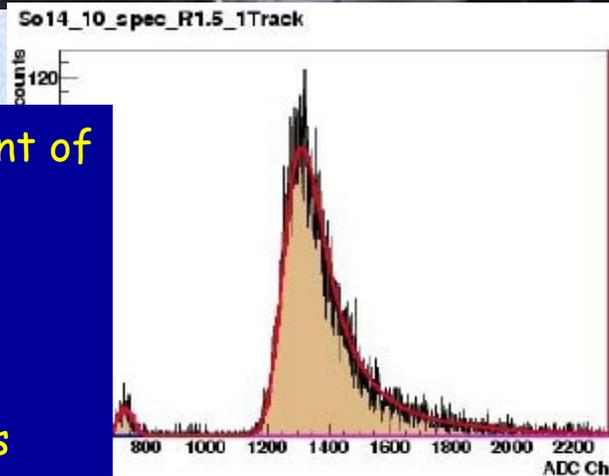
Detector under test



Reconstructed hits with detector signal

Goal: precise measurement of the response of sCVD diamonds; Reference sensor

Data analysis in progress



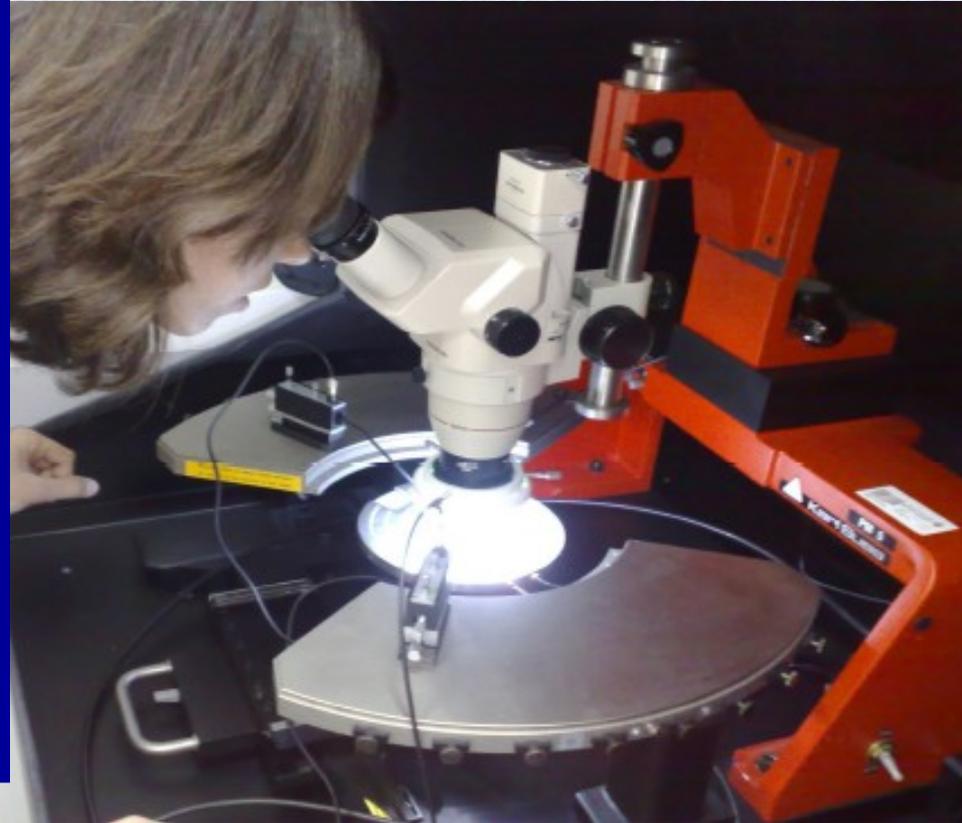
Sensor response with the track pointing to active detector area

A dedicated silicon lab is created in Tel Aviv:

- Computer monitored prob station
- Computer supported  $I(V)$ ,  $C(V)$  measurements

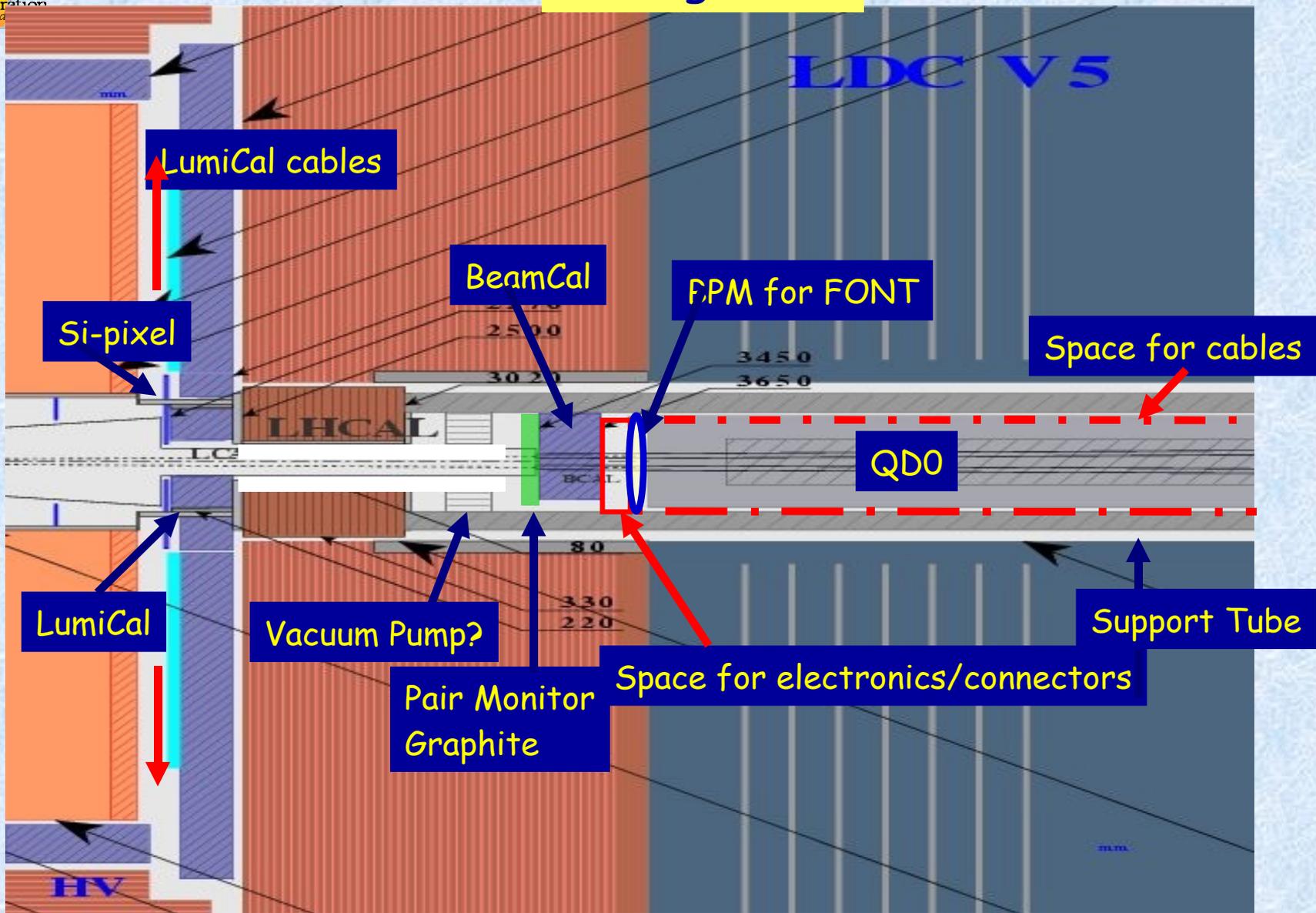
in preparation:

- clean room
- spectroscopic set-up



A dedicated HEP lab building is designed for detector R&D, planned to be ready mid 2009

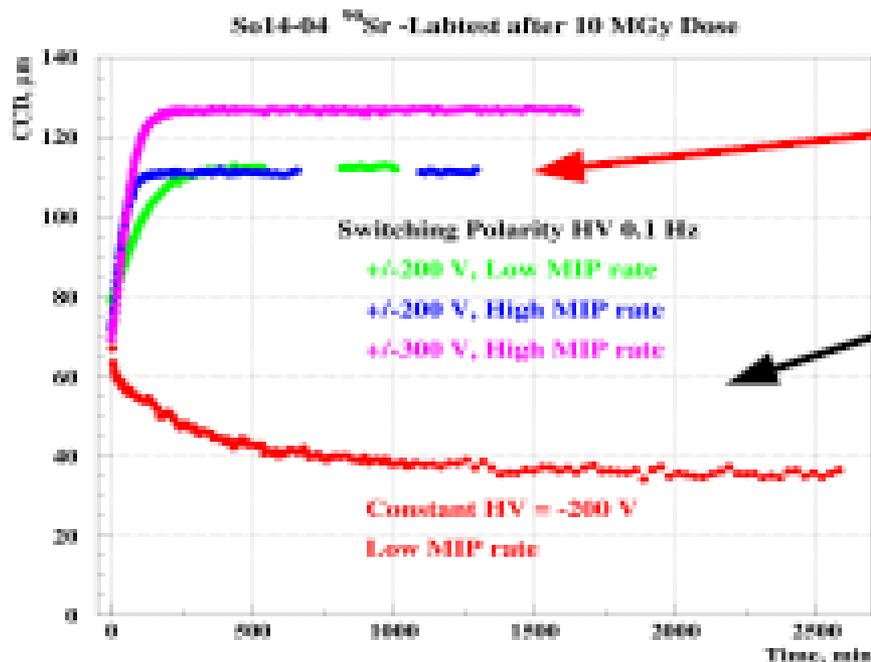
# Integration



# Tests at Zeuthen 2009:

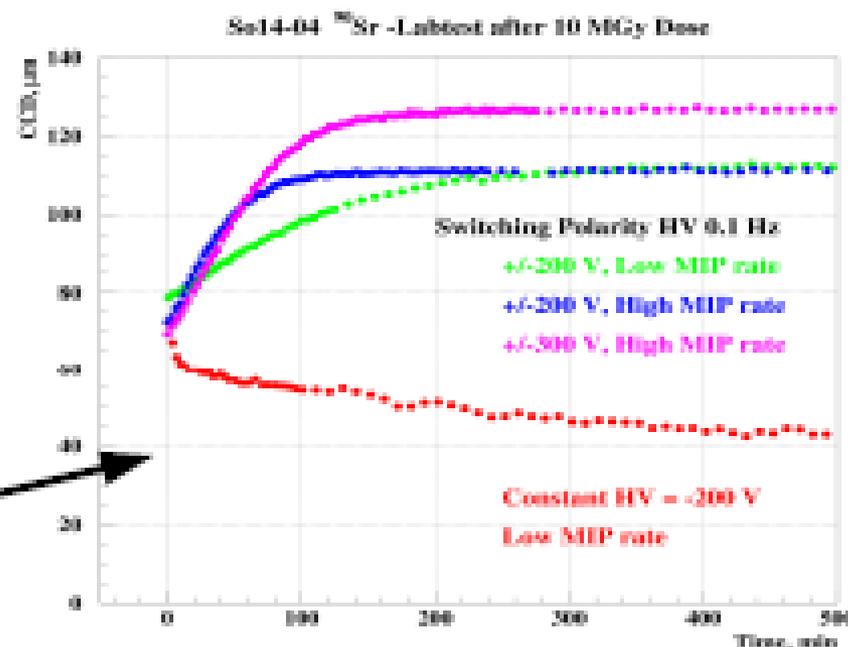
## CCD vs time

After 10 MGy



Same steady state CCD?  
Short living traps?

All data



First 500 min data taking: